

LOW PHASE NOISE CLOCK MULTIPLIER

ICS601-21

Description

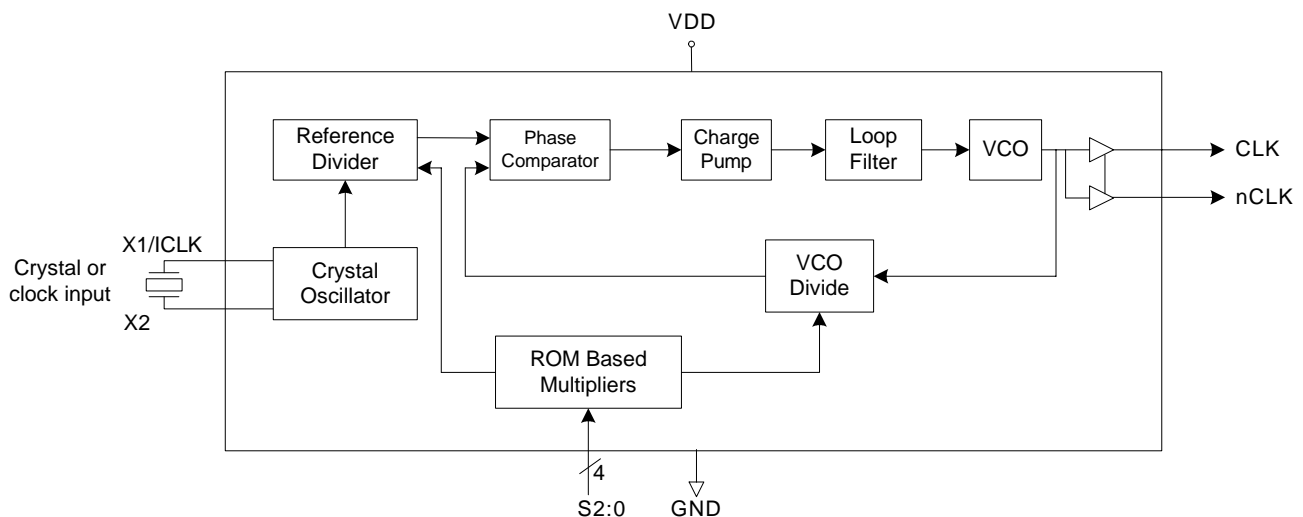
The ICS601-21 is a low-cost, low phase noise, high performance clock synthesizer for applications which require low phase noise and low jitter. It is ICS' lowest phase noise multiplier. Using ICS' patented analog and digital Phase Locked Loop (PLL) techniques, the chip accepts a 10 - 27 MHz crystal or clock input, and produces output clocks up to 220 MHz at 3.3 V.

This product is intended for clock generation. It has low output jitter (variation in the output period), but input to output skew and jitter are not defined nor guaranteed.

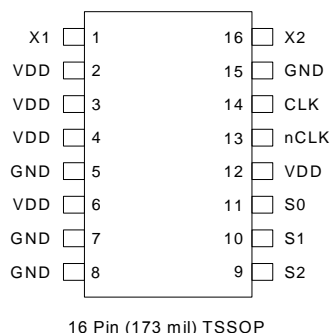
Features

- Fully integrated PLL, no external loop filter required
- Differential 3.3 V LVPECL outputs
- Uses fundamental 10 - 27 MHz crystal or clock
- Output clocks up to 220 MHz at 3.3 V
- Low phase noise: -122 dBc/Hz at 10 kHz
- Low jitter - 15 ps one sigma typ.
- Powerdown mode lowers power consumption
- Packaged in 16-pin TSSOP
- Advanced, low power, sub-micron CMOS process
- Operating voltage of 3.3 V
- Commercial temperature range available
- Available in Pb (lead) free package

Block Diagram



Pin Assignment



16 Pin (173 mil) TSSOP

Multiplier Select Table

| S2 | S1 | S0 | Multiplier |
|----|----|----|------------|
| 0 | 0 | 0 | x1 |
| 0 | 0 | 1 | x2 |
| 0 | 1 | 0 | x3 |
| 0 | 1 | 1 | x4 |
| 1 | 0 | 0 | x5 |
| 1 | 0 | 1 | x6 |
| 1 | 1 | 0 | x8 |
| 1 | 1 | 1 | x16 |

0 = connect directly to ground

1 = connect directly to VDD

Pin Descriptions

| Pin Number | Pin Name | Pin Type | Pin Description |
|------------|----------|----------|-----------------------------------------------------------------------------------------------------------------|
| 1 | X1 | XI | Crystal or clock input. Connect to a 10-27 MHz fundamental parallel mode crystal or clock input. |
| 2 - 4 | VDD | Power | Connect to +3.3 V. |
| 5 | GND | Power | Connect to ground. |
| 6 | VDD | Power | Connect to +3.3 V. |
| 7 - 8 | GND | Power | Connect to ground. |
| 9 | S2 | Input | Select pin 2. Internal pull-up resistor. |
| 10 | S1 | Input | Select pin 1. Internal pull-up resistor. |
| 11 | S0 | Input | Select pin 0. Internal pull-up resistor. |
| 12 | VDD | Power | Connect to +3.3 V. |
| 13 | nCLK | Output | Inverted differential clock output. |
| 14 | CLK | Output | Differential clock output. |
| 15 | GND | Power | Connect to ground. |
| 16 | X2 | XO | Crystal connection. Connect to 10-27MHz fundamental parallel mode crystal or leave unconnected for clock input. |

External Components

The ICS601-21 requires a minimum number of external components for proper operation. Decoupling capacitors of 0.01 μF and 0.1 μF should be connected between VDD and GND, as close to the part as possible. A 50 Ω terminating resistor should be used on each clock output. (See termination diagram on page 5). The crystal must be connected as close to the chip as possible. The crystal should be fundamental mode, parallel resonant. Do not use third overtone. For exact tuning when using a crystal, capacitors should be connected from pins X1 to ground and X2 to ground. In general, the value of these capacitors is given by the following equation, where CL is the crystal load capacitance: Crystal caps (pF) = (CL-5) x 2. So for a crystal with 16 pF load capacitance, two 22 pF caps can be used. For any given board layout, ICS can measure the board capacitance and recommend the exact capacitance value to use.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS601-21. These ratings, which are standard values for ICS commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| Item | Rating |
|---------------------------------------------------|---------------------|
| Supply Voltage, VDD | 7 V |
| All Inputs and Outputs | -0.5 V to VDD+0.5 V |
| Ambient Operating Temperature, Commercial version | 0 to +70 °C |
| Storage Temperature | -65 to +150 °C |
| Junction Temperature | 125 °C |
| Soldering Temperature | 260 °C |

Recommended Operation Conditions

| Parameter | Min. | Typ. | Max. | Units |
|---------------------------------------------------|------|------|------|-------|
| Ambient Operating Temperature | 0 | | +70 | °C |
| Power Supply Voltage (measured in respect to GND) | +3.0 | | +3.6 | V |

DC Electrical Characteristics

VDD=3.3 V \pm 10%, Ambient temperature 0 to +70°C

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Units |
|--------------------|-----------------|------------------|---------|------|---------|-------|
| Operating Voltage | VDD | | 3.0 | | 3.6 | V |
| Input High Voltage | V _{IH} | X1/ICLK pin only | VDD/2+1 | | | V |
| Input Low Voltage | V _{IL} | X1/ICLK pin only | | | VDD/2-1 | V |

DC Electrical Characteristics (continued)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Units |
|--------------------------|-------------|-------------------|---------|------|---------|------------|
| Input High Voltage | V_{IH} | Input select pins | 2 | | VDD | V |
| Input Low Voltage | V_{IL} | Input select pins | | | 0.8 | V |
| Output High Voltage | V_{OH} | Note 1 | VDD-1.4 | | VDD-1.0 | V |
| Output Low Voltage | V_{OL} | Note 1 | VDD-2.0 | | VDD-1.7 | V |
| Output Voltage Swing | V_{swing} | Peak to Peak | 0.6 | | 0.95 | V |
| Operating Supply Current | IDD | Note 1, 125 MHz | | 30 | 45 | mA |
| Input Capacitance | C_{IN} | Input select pins | | 5 | | pF |
| On Chip Pull-up Resistor | R_{PU} | Input select pins | | 510 | | k Ω |

Note 1: Outputs terminated with 50 Ω to VDD-2V

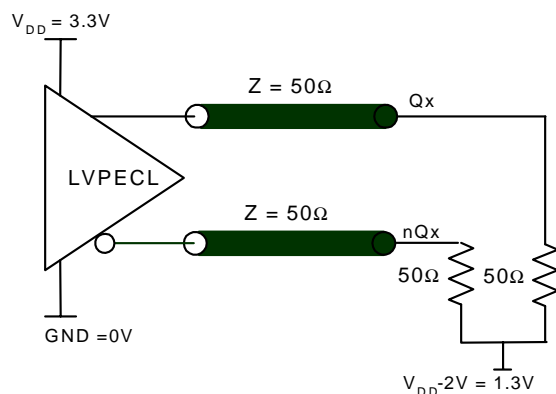
AC Electrical Characteristics

VDD = 3.3 V \pm 10%, Ambient Temperature 0 to +70° C

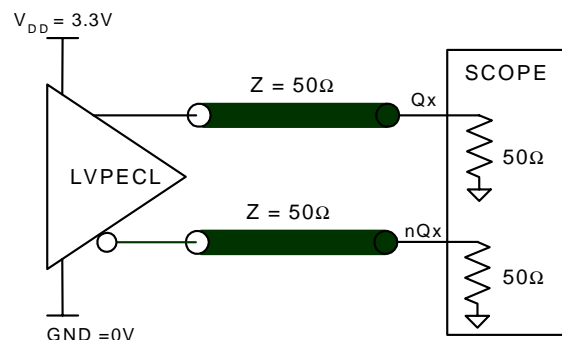
| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Units |
|------------------------------------------------|----------|---------------------|------|----------|----------|--------|
| Crystal Input Frequency | F_{in} | Note 2 | 10 | | 27 | MHz |
| Output Frequency | | | 10 | | 220 | MHz |
| Output Rise Time | t_{OR} | 20% to 80%, no load | | 600 | 900 | ps |
| Output Fall Time | t_{OF} | 80% to 20%, no load | | 900 | 1200 | ps |
| Output Clock Duty Cycle | | at VDD/2 | 45 | 50 | 55 | % |
| Maximum Absolute Jitter, short term, 125 MHz | | No load | | \pm 50 | \pm 75 | ps |
| Maximum Jitter, one sigma, 125 MHz (x5) | | No load | | 12 | 20 | ps |
| Phase Noise, relative to carrier, 125 MHz (x5) | | 100 Hz offset | -90 | -94 | | dBc/Hz |
| Phase Noise, relative to carrier, 125 MHz (x5) | | 1 kHz | -116 | -120 | | dBc/Hz |
| Phase Noise, relative to carrier, 125 MHz (x5) | | 10 kHz offset | -118 | -122 | | dBc/Hz |
| Phase Noise, relative to carrier, 125 MHz (x5) | | 100 kHz offset | -115 | -119 | | dBc/Hz |

Note 2: Input frequency limited by maximum output frequency and multiplication factor (I.e. For 16x, maximum input frequency is 13.75 MHz).

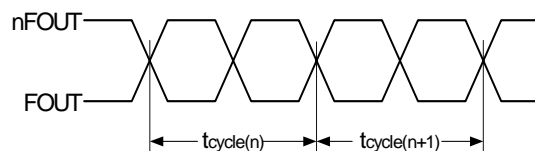
Parameter Measurement Information



3.3V LVPECL Driver Termination



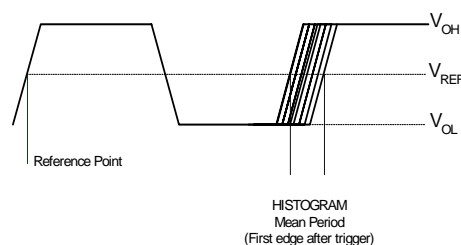
3.3V Output Load AC Test Circuit



$$t_{jit(cc)} = t_{cycle(n)} - t_{cycle(n+1)}$$

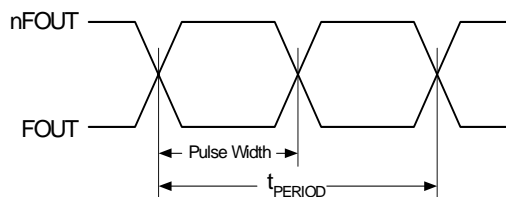
1000 Cycles

CYCLE-TO-CYCLE JITTER

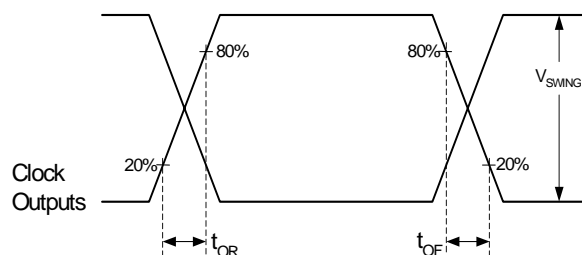


1s contains 68.26% of all measurements
 2s contains 95.4% of all measurements
 3s contains 99.73% of all measurements
 4s contains 99.99366% of all measurements
 6s contains (100-1.973x10⁻⁷)% of all measurements

Period Jitter



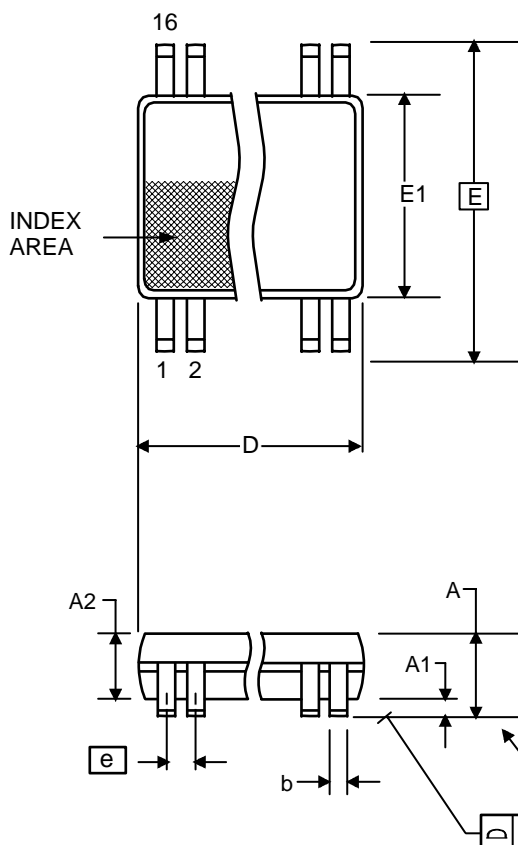
$$ODC = \frac{t_{PW}}{t_{PERIOD}}$$

OUTPUT DUTY CYCLE AND t_{PERIOD} 

OUTPUT RISE/FALL TIME

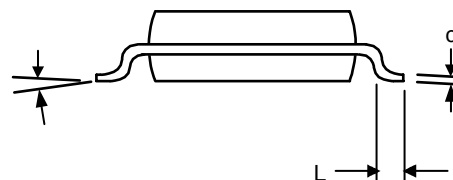
Package Outline and Package Dimensions (16-pin TSSOP, 173 Mil. Narrow Body)

Package dimensions are kept current with JEDEC Publication No. 95



| Symbol | Millimeters | | Inches* | |
|----------|-------------|------|--------------|-------|
| | Min | Max | Min | Max |
| A | -- | 1.20 | -- | 0.047 |
| A1 | 0.05 | 0.15 | 0.002 | 0.006 |
| A2 | 0.80 | 1.05 | 0.032 | 0.041 |
| b | 0.19 | 0.30 | 0.007 | 0.012 |
| C | 0.09 | 0.20 | 0.0035 | 0.008 |
| D | 4.90 | 5.1 | 0.193 | 0.201 |
| E | 6.40 BASIC | | 0.252 BASIC | |
| E1 | 4.30 | 4.50 | 0.169 | 0.177 |
| e | 0.65 Basic | | 0.0256 Basic | |
| L | 0.45 | 0.75 | 0.018 | 0.030 |
| α | 0° | 8° | 0° | 8° |
| aaa | -- | 0.10 | -- | 0.004 |

*For reference only. Controlling dimensions in mm.



Ordering Information

| Part / Order Number | Marking | Shipping Packaging | Package | Temperature |
|---------------------|------------|--------------------|--------------|-------------|
| 601G-21 | ICS601G-21 | Tubes | 16-pin TSSOP | 0 to +70° C |
| 601G-21T | ICS601G-21 | Tape and Reel | 16-pin TSSOP | 0 to +70° C |
| 601G-21LF | 601G-21LF | Tubes | 16-pin TSSOP | 0 to +70° C |
| 601G-21LFT | 601G-21LF | Tape and Reel | 16-pin TSSOP | 0 to +70° C |

Parts that are ordered with a "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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